MPQ2169



6V, Dual 1.4A/1.4A or 2A/0.8A Low Quiescent Current, Synchronous Buck with PG and SS AEC-Q100 Qualified

DESCRIPTION

The MPQ2169 is an internally compensated, dual, PWM, synchronous, step-down regulator that operates from a 2.7V to 6V input and generates an output voltage as low as 0.6V. The MPQ2169 can be configured as a 1.4A/1.4A or 2A/0.8A output current regulator and is ideal for powering portable equipment that runs on a single-cell lithium-ion (Li+) battery due to its low 60µA quiescent current.

The MPQ2169 integrates dual, $60m\Omega$, high-side switches and $25m\Omega$ synchronous rectifiers to achieve high efficiency without an external Schottky diode. The MPQ2169 has peakcurrent-mode control and internal compensation and is capable of low dropout configurations when the part works in AAM mode. Both channels can operate at 100% duty cycle.

Full protection features include cycle-by-cycle current limit and thermal shutdown.

The MPQ2169 requires a minimal number of readily available, standard, external components and is available in QFN-18 (2mmx3mm) and QFN-18 (2.5mmx3.5mm) packages.

FEATURES

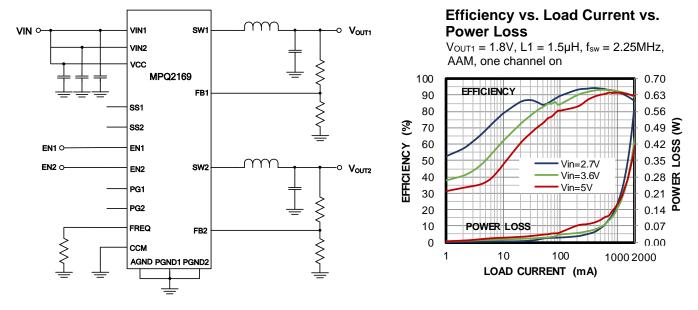
- 2.7V to 6V Operating Input Range
- 1.4A/1.4A or 2A/0.8A Continuous Current
- 60mΩ/25mΩ R_{DS(ON)}
- Programmed Frequency up to 3MHz
- External Sync Clock up to 3MHz
- 180° Phase-Shifted Operation
- Power Good (PG) Indicators
- External Soft Start (SS) and Track
- Adjustable Advanced Asynchronous Mode (AAM) or Forced Continuous Conduction Mode (FCCM)
- Peak Efficiency >90%
- Output Adjustable from 0.6V to 5.5V in AAM Mode, 0.6V to 0.5 x V_{IN} in FCCM
- 100% Duty Cycle Operation
- 60µA Quiescent Current
- Cycle-by-Cycle Over-Current Protection (OCP)
- Short-Circuit Protection (SCP) with Hiccup Mode and Valley Current Detection
- Thermal Shutdown
- Available in QFN-18 (2mmx3mm) and QFN-18 (2.5mmx3.5mm) Packages
- Available in a Wettable Flank Package
- Available in AEC-Q100 Grade-1

APPLICATIONS

- Automotive Infotainment
- Automotive Clusters
- Automotive Telematics
- Battery-Power Devices
- Portable Instruments

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TYPICAL APPLICATION



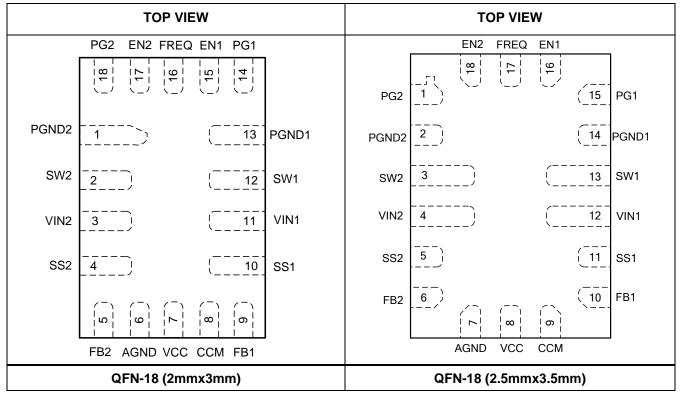


Part Number*	Package	Top Marking	MSL Rating**		
MPQ2169GDE-AEC1***	QFN-18 (2mmx3mm)	See Below	1		
MPQ2169GRHE-AEC1***	QFN-18 (2.5mmx3.5mm)	See Below	1		
* For Tape &	Reel, add suffix -Z (e.g.: MPC	Q2169GDE-AEC1-	Z).		
	** Moisture Sensitivity Level	Rating			
	*** Wettable flank				
	ì	ΤΟΡ ΜΑ	RKING		
(MPQ2169GDE-AE		(MPQ2169GRHE-AEC1)			
	-01)				
			_		
BJL		AZ	Z		
YWW		YW	W		
LLL		LLL			
oduct code of MPQ2169GDE-A	AEC1 AZZ: Prod	duct code of MPQ2	169GRHE-AEC1		

ORDERING INFORMATION

BJL: Product code of MPQ2169GDE-AEC1 Y: Year code WW: Week code LLL: Lot number

AZZ: Product code of MPQ2169GRHE-AEC1 Y: Year code WW: Week code LLL: Lot number



PACKAGE REFERENCE

PIN FUNCTIONS

QFN-18 (2x3) Pin #	QFN-18 (2.5x3.5) Pin #	Name	Description		
1	2	PGND2	Power ground of channel 2. Connect PGND2 with larger copper areas to the negative terminals of the input and output capacitors. PGND2 must connect to PGND1 externally on board.		
2	3	SW2	Switch node connection to the inductor for channel 2. SW2 connects to the internal high- and low-side power MOSFET switches of the channel 2 buck.		
3	4	VIN2	Input supply for channel 2. Place a decoupling capacitor to ground close to VIN2 to reduce switching spikes.		
4	5	SS2	Soft start for channel 2. Place a capacitor from SS2 to GND to set the soft-start time externally. Floating this pin will activate the internal default 0.5ms soft-start setting.		
5	6	FB2	Feedback for channel 2. FB2 is the input to the error amplifier of channel 2. An external resistive divider connects FB2 between the output and ground. The voltage on FB2 compares to the internal 0.6V reference to set the regulation voltage of channel 2.		
6	7	AGND	Analog ground. Connect AGND to PGND externally.		
7	8	VCC	Power supply to the internal regulator for both channels. Decouple with a 0.1μ F to 1μ F capacitor between VCC and AGND. Connect VIN1, VIN2, VCC together externally, it is not recommended to power them from separated power supply.		
8	9	ССМ	AAM or forced CCM control. Pull CCM high to enter forced CCM mode; pull CCM low to enter AAM mode at light load. Do not float CCM.		
9	10	FB1	Feedback for channel 1. FB1 is the input to the error amplifier of channel 1. An external resistive divider connects FB1 between the output and GND. The voltage on FB1 compares to the internal 0.6V reference to set the regulation voltage of channel 1.		
10	11	SS1	Soft start for channel 1. Place a capacitor from SS1 to GND to set the soft-start time externally. Floating this pin will activate the internal default 0.5ms soft-start setting.		
11	12	VIN1	Input supply for channel 1. Place a decoupling capacitor to ground close to VIN1 to reduce switching spikes.		
12	13	SW1	Switch node connection to the inductor for channel 1. SW1 connects to the internal high- and low-side power MOSFET switches of the channel 1 buck.		
13	14	PGND1	Power ground of channel 1. Connect PGND1 with larger copper areas to the negative terminals of the input and output capacitors. PGND1 must connect to PGND2 externally on board.		
14	15	PG1	Power good for channel 1. The output of PG1 is an open drain, a pull-up resistor to power source is needed if used. PG1 is pulled high when V_{FB1} reaches 90% of V_{REF} , it is pulled low to GND if V_{FB1} drops to 82% of V_{REF} .		
1	2	PGND2	Power ground of channel 2. Connect PGND2 with larger copper areas to the negative terminals of the input and output capacitors. PGND2 must connect to PGND1 externally on board.		
2	3	SW2	Switch node connection to the inductor for channel 2. SW2 connects to the internal high- and low-side power MOSFET switches of the channel 2 buck.		
3	4	VIN2	Input supply for channel 2. Place a decoupling capacitor to ground close to VIN2 to reduce switching spikes.		

ABSOLUTE MAXIMUM RATINGS (1)

Supply voltage (VIN)	6.5V
V _{SW}	
All other pins	0.3V to +6.5V
Junction temperature	150°C
Lead temperature	260°C
Storage temperature	65°C to 150°C
Continuous power dissipation	n (T _A = +25°C) ⁽²⁾
QFN-18 (2mmx3mm)	1.78W
QFN-18 (2.5mmx3.5mm)	2.5W

ESD Rating

Human-body model (HE	3M)	<u>+</u> 2kV
Charged-device model	(CDM)	±750V

Recommended Operating Conditions

Supply voltage (VIN)	
Output voltage (Vout)
	. 0.6V to 5.5V in AAM mode
(0.6V to 0.5 x V_{IN} in FCCM ⁽³⁾
Operating junction te	emp40°C to +125°C ⁽⁴⁾

Thermal Resistance	θյΑ	$\boldsymbol{\theta}_{JC}$
QFN-18 (2mmx3mm)		
JESD51-7 ⁽⁵⁾	70	15°C/W
QFN-18 (2.5mmx3.5mm)		
JESD51-7 ⁽⁵⁾	50	12°C/W
EV2169-RH-00A ⁽⁶⁾	34.8	2.7°C/W

Notes:

- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance θ_{JA}, and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX)-T_A)/θ_{JA}. Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the regulator to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- Operation in FCCM with a higher V_{OUT} may be possible. Contact an MPS FAE for details.
- Operating devices at junction temperatures greater than 125°C is possible, please contact MPS for details.
- 5) Measured on JESD51-7, 4-layer PCB.
- Measured on MPS standard EVB, 6.35cm*6.35cm, 2oz cooper thick, 4-Layer PCB.

¹⁾ Exceeding these ratings may damage the device.

ELECTRICAL CHARACTERISTICS

$V_{IN} = 5V$, $T_J = -40^{\circ}C$ to $+125^{\circ}C$, unless otherwise noted. Typical values are at $T_J = 25^{\circ}C$.

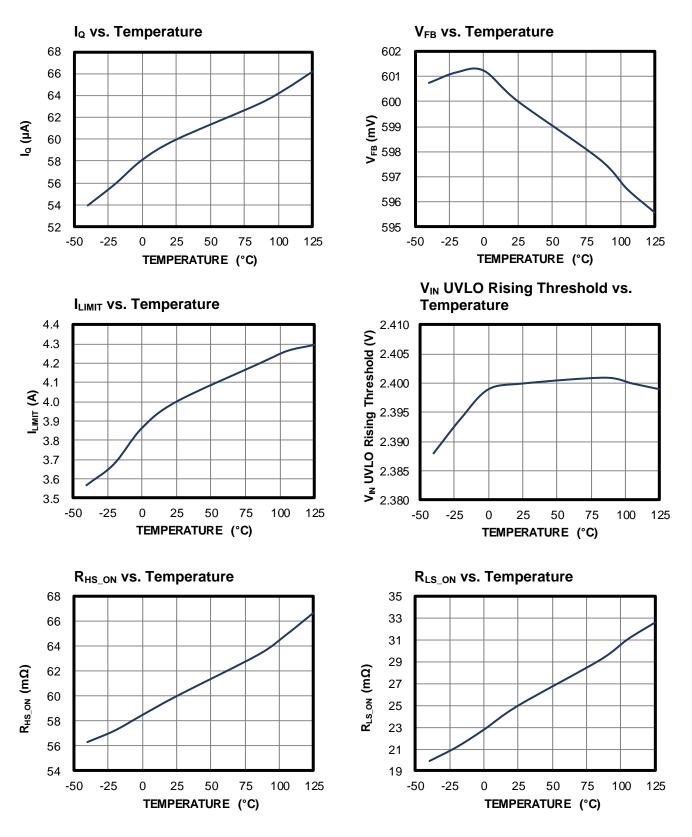
Parameters	Symbol	Condition	Min	Тур	Max	Units
Supply current (quiescent)	ΙQ	$V_{IN} = 5V, V_{EN} = 2V, V_{FB} = 0.65V, no switching$		60	80	μA
		V _{EN} = 0V, CCM = GND, T _J = 25°C		0	0.2	μA
Shutdown current	ISHDN	$V_{EN} = 0V$, CCM=GND, T _J = - 40°C to +85°C ⁽⁷⁾		0	1.5	μA
		V _{EN} = 0V, CCM = GND, T _J = +85°C to +125°C			5	μA
V _{IN} under-voltage lockout threshold	IN _{UVLO}	Rising edge		2.4	2.55	V
V _{IN} under-voltage lockout hysteresis	IN _{UVLO_HYS}			230		mV
Degulated ED valtage	Vfb	$T_J = +25^{\circ}C$	0.593	0.600	0.607	V
Regulated FB voltage	VFB	$T_{J} = -40^{\circ}C$ to $+125^{\circ}C$	0.588	0.600	0.612	V
FB input current	I _{FB}	V _{FB} = 0.65V		0	50	nA
EN high threshold	Ven_h		1.6			V
EN low threshold	Ven_l				0.4	V
EN input current		$V_{EN} = 2V$		0	0.1	
EN input current	I _{EN}	$V_{EN} = 0V$		0	0.1	μA
HS switch on resistance	R _{DSON_P}	$V_{IN} = 5V$		60	90	mΩ
LS switch on resistance	R _{DSON_N}	$V_{IN} = 5V$		25	45	mΩ
SW leakage current	Isw_lk	$V_{EN} = 0V$, $V_{IN} = 6V$, $V_{SW} = 0V$ and $6V$, $T_J = 25^{\circ}C$	-1	0	1	μA
HS switch current limit (7)	IHS_LIMIT	Sourcing	3.0	4.0	5.6	Α
LS valley current limit (7)	IVALLEY			3.4		Α
LS switch current limit	ILS_LIMIT	Sinking, CCM	1			Α
		$R_{FREQ} = 665 k\Omega$	298	350	402	kHz
Oscillator frequency accuracy	fsw	$R_{FREQ} = 200 k\Omega$	850	1000	1150	kHz
		$R_{FREQ} = 51k\Omega$	2700	3000	3300	kHz
Sync frequency range	fsync		0.35		3	MHz
Phase shift				180		0
Minimum on time ⁽⁷⁾	Ton_min			55		ns
Minimum off time (7)	TOFF_MIN			50		ns
Maximum duty cycle	D _{MAX}			100		%
Thermal shutdown threshold ⁽⁷⁾	TD			175		0°
Thermal shutdown hysteresis ⁽⁷⁾	T _{D_HYS}			40		°C
Soft-start charging current	I _{SS}	V _{SS} = 0V	2	3.2	5	μA
Power good rising threshold	PGOOD _{Vth-Hi}		0.85	0.9	0.95	V_{FB}
Power good falling threshold	PGOOD _{Vth-Lo}		0.77	0.82	0.87	V _{FB}
Power good threshold hystersis	PGOOD _{Vth-Hys}			0.08		V _{FB}
Power good rising delay	T _{PGOOD_R}			30		μs
Power good falling delay	T _{PGOOD_F}			40		μs
CCM on threshold			1.6			V
CCM off threshold					0.4	V

Note:

7) Not tested in production and guaranteed by design and characterization.

TYPICAL CHARACTERISTICS

 $V_{IN} = 5V$, $T_J = 25^{\circ}C$, unless otherwise noted.

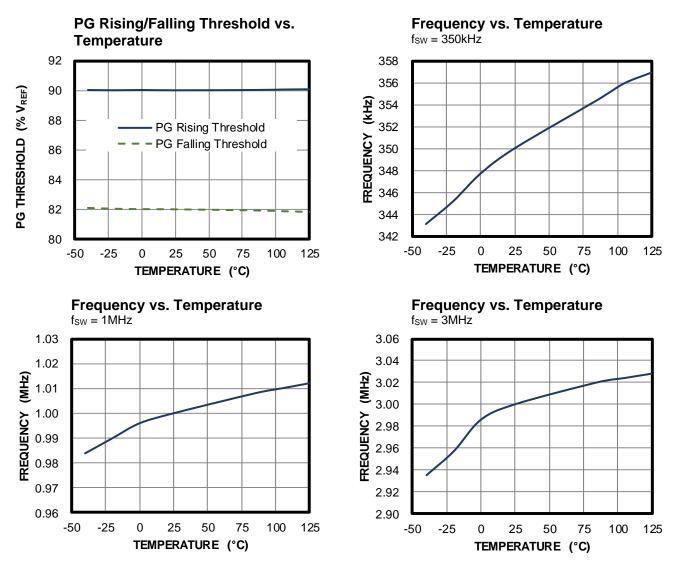


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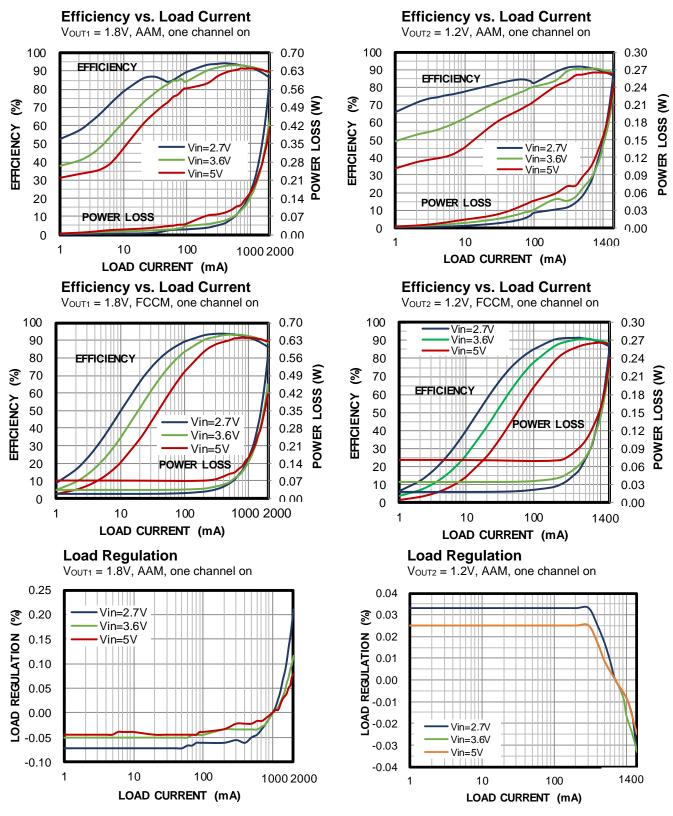
TYPICAL CHARACTERISTICS (continued)

 $V_{IN} = 5V$, $T_J = 25^{\circ}C$, unless otherwise noted.



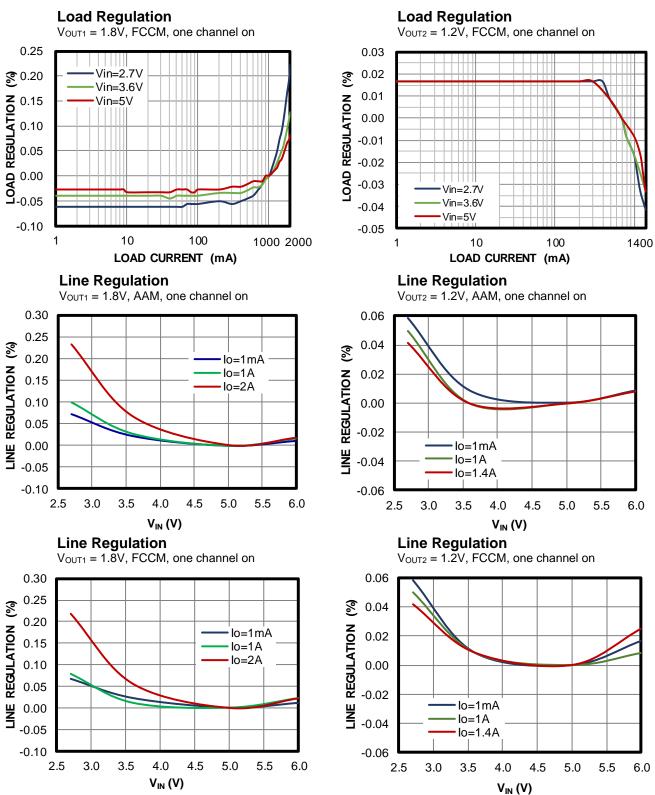
TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} = 5V, V_{OUT1} = 1.8V, V_{OUT2} = 1.2V, L1 = L2 = 1.5µH, f_{SW} = 2.25MHz, T_{A} = 25°C, unless otherwise noted.



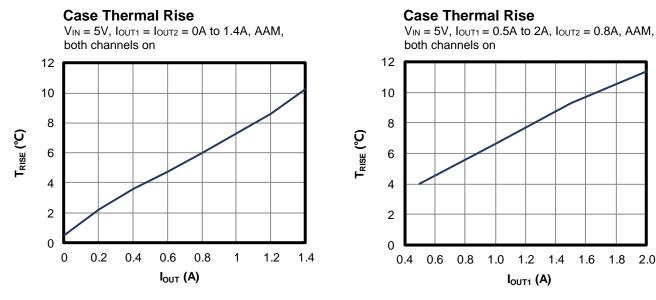
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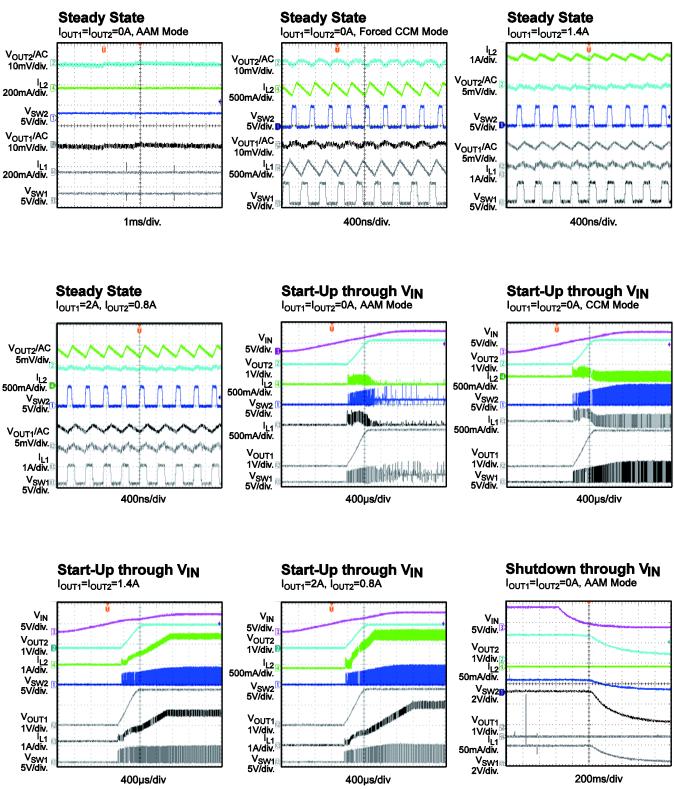


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 $V_{IN} = 5V$, $V_{OUT1} = 1.8V$, $V_{OUT2} = 1.2V$, $L1 = L2 = 1.5\mu$ H, $f_{SW} = 2.25$ MHz, $T_A = 25$ °C, unless otherwise noted.

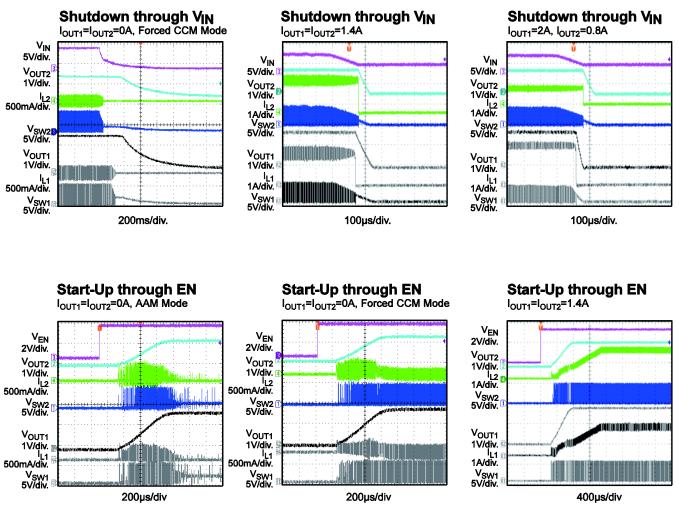


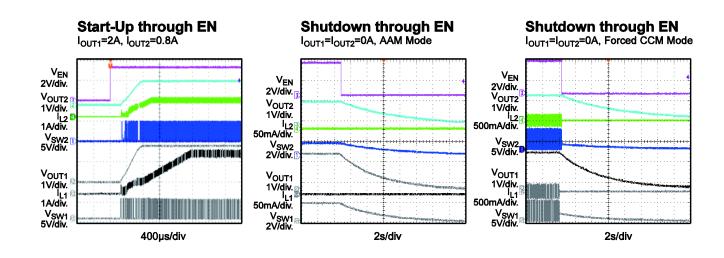
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 V_{IN} = 5V, V_{OUT1} = 1.8V, V_{OUT2} = 1.2V, L1 = L2 = 1.5 $\mu H,~f_{SW}$ = 2.25MHz, T_A = 25°C, unless otherwise noted.

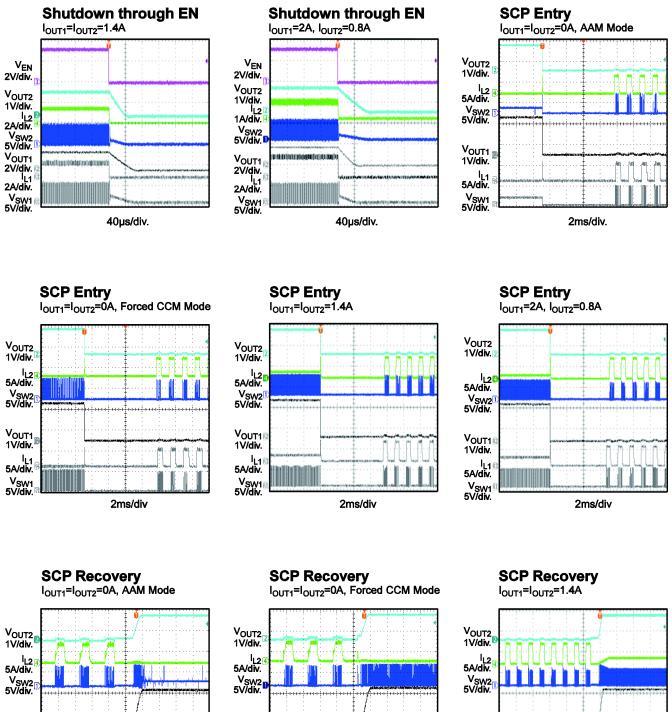


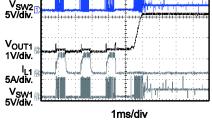


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 V_{IN} = 5V, V_{OUT1} = 1.8V, V_{OUT2} = 1.2V, L1 = L2 = 1.5 $\mu H,~f_{SW}$ = 2.25MHz, T_A = 25°C, unless otherwise noted.





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1ms/div

VOUT1

1V/div.

5A/div

V_{SW1} 5V/div.

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V_{OUT1}

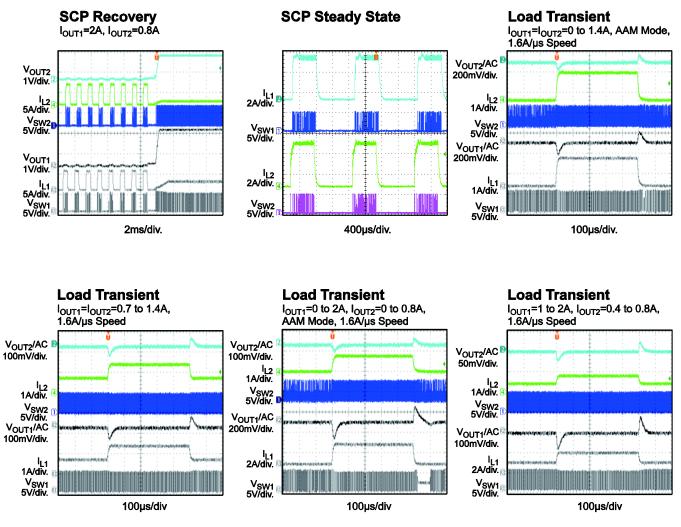
1V/div.

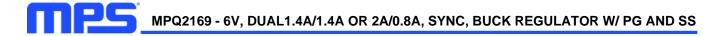
l_{L1} 5A/div.

V_{SW1} 5V/div.

2ms/div

 V_{IN} = 5V, V_{OUT1} = 1.8V, V_{OUT2} = 1.2V, L1 = L2 = 1.5µH, f_{SW} = 2.25MHz, T_A = 25°C, unless otherwise noted.





BLOCK DIAGRAM

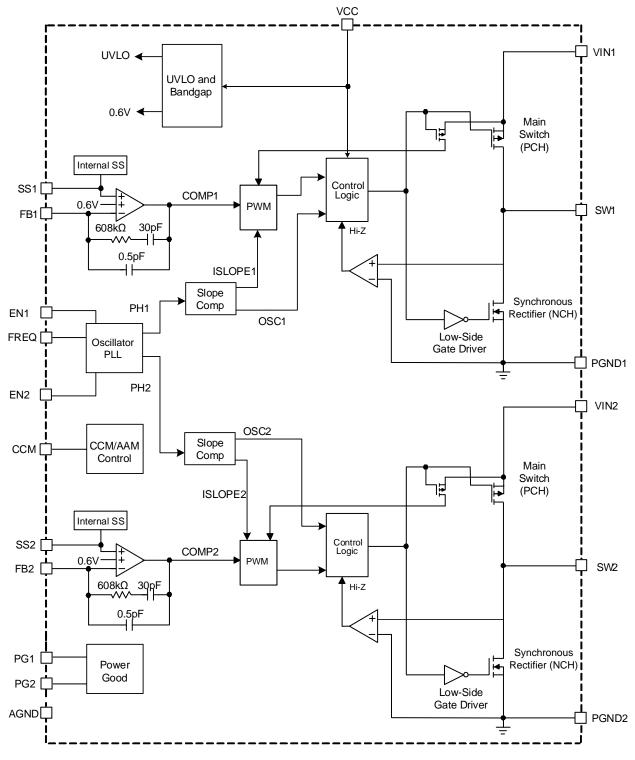


Figure 1: Functional Block Diagram

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OPERATION

The MPQ2169 is a fully integrated, dualchannel, synchronous, step-down converter. Both channels use peak-current-mode control with internal compensation for fast transient response and cycle-to-cycle current limiting.

The MPQ2169 is optimized for low-voltage, portable applications where efficiency and small size are critical.

180° Out-of-Phase Operation

The MPQ2169 operates the two channels in 180° out-of-phase operation to reduce the input current ripple, so a smaller input bypass capacitor can be used. When both channels operate in continuous conduction mode (CCM), two internal clocks are used (see Figure 2). The high-side MOSFET (HS-FET) is turned on at the clock's rising edge of the corresponding channel.

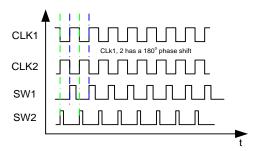


Figure 2: 180° Out-of-Phase Operation

At low dropout mode, when the switching frequency is stretched out for each channel, the MPQ2169 runs at a fixed off time with its own independent switching frequency. After the input voltage rises high again, frequency stretch mode ends, and pulse-width modulation (PWM) mode resumes and synchronizes with the master oscillator for out-of-phase operation.

Light-Load Operation

In light-load condition, the MPQ2169 can work in two different operating modes by setting CCM to different statuses.

The MPQ2169 works in forced continuous conduction mode (FCCM) when the CCM pin is pulled above 1.6V. The MPQ2169 works with a fixed frequency from no load to full load in this mode. The advantage of CCM is the controllable frequency and lower output ripple at light load. When the part works in FCCM, the

max output voltage (V_{OUT}) must be limited to 0.5 x V_{IN} . The shutdown current in FCCM (50µA at 3.3V) is much higher than that in advanced asynchronous mode (AAM) due to some active internal circuits. It is recommended to pull CCM low when the MPQ2169 has been shut down due to a high shutdown current.

The MPQ2169 works in AAM when CCM is pulled below 0.4V. AAM is used to optimize efficiency during light-load and no-load conditions.

When AAM is enabled, the MPQ2169 first enters non-synchronous operation as the inductor current approaches zero at light load. If the load decreases further or is at no load, which makes the internal COMP voltage (V_{COMP}) decrease to the set value, then the MPQ2169 enters AAM. In AAM, the internal clock is reset whenever V_{COMP} crosses over the set value, and the crossover time is taken as the benchmark of the next clock. When the load increases and V_{COMP} is higher than the set value, the operation mode is in CCM or discontinuous conduction mode (DCM), which have a constant switching frequency.

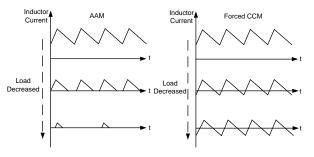


Figure 3: AAM and Forced CCM

Enable

EN is a digital control pin that turns the regulator on and off.

When EN is pulled below falling threshold voltage 0.4V, the chip is shutdown. Forcing this pin above EN rising threshold voltage 1.6V turns on the part. Do not float EN.

Soft Start (SS)

The MPQ2169 has a built-in soft start that ramps up the output voltage at a controlled slew rate, preventing an overshoot at start-up. The soft-start time is about 0.5ms, typically.

The soft-start time (t_{SS}) can also be programmed by an external capacitor connected to SS, shown in Equation (1):

$$t_{ss}(ms) = \frac{C_{ss}(nF) \times V_{RFF}(V)}{I_{ss}(\mu A)}$$
(1)

Where C_{SS} is the external SS capacitor, V_{REF} is the internal reference voltage (0.6V), and I_{SS} is the 3.2µA SS charge current.

Oscillator and SYNC Function

The internal oscillator frequency is set by a single external resistor (R_{FREQ}) connected between FREQ and ground. The frequency-setting resistor should be located close to the device. The relationship between the oscillator frequency and R_{FREQ} is shown in Figure 4.

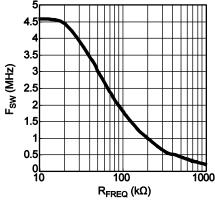


Figure 4: Fsw vs. RFREQ

FREQ can also be used to synchronize the internal oscillator to an external clock. The rising edge of the channel 1 clock is synchronized to the external clock's rising edge, while the channel 2 clock remains at 180° out-of-phase to channel 1. The recommended external SYNC frequency is in the range of 350kHz to 3MHz. While there is no pulse width requirement, note that there is always parasitic capacitance of the pad there, so if the pulse width is too short, a clear rising and falling edge may not be seen. The pulse is recommended to be longer than 100ns.

Ensure to add the external SYNC clock (350kHz to 3MHz) before the device starts up and keep the SYNC clock until the device is off. Constant high, constant low and high/low transition for the SYNC signal are all not allowed during the operation.

Power Good (PG)

The MPQ2169 has one power good (PG) output to indicate normal operation after t_{SS} . PG is the open drain of an internal MOSFET. It should be connected to VIN, VCC, or an external voltage source through a resistor (i.e.: 100k Ω). After the input voltage is applied, the MOSFET is turned on and PG is pulled to GND before SS is ready. After the FB voltage (V_{FB}) reaches 90% of the reference voltage (V_{REF}), the MOSFET turns off and PG is pulled high by an external voltage source. When V_{FB} drops to 82% of V_{REF}, the PG voltage is pulled to GND to indicate a failure output.

Current Limit and Short Circuit

Each channel of the MPQ2169 has a typical 4A current limit for the high-side switch. When FB drops to 60% of the reference value and SS is sufficient, the MPQ2169 treats this as a short and attempts to recover with hiccup mode.

In hiccup mode, the MPQ2169 disables the output power stage, slowly discharges the softstart cap, and soft starts automatically. If the short-circuit condition still remains, the MPQ2169 repeats this operation cycle until the short circuit is removed and the output rises back to regulation levels.

Dropout Operation

The MPQ2169 allows the high-side switch to remain on for more than one switching cycle and increases the duty cycle while the input voltage drops down to the output voltage. When the duty cycle reaches 100%, the high-side switch turns on to deliver current to the output up to its current limit. The output voltage is then the difference between the input voltage, the voltage drop across the main switch, and the inductor. Do not use FCCM in applications that can be subject to dropout operation.

Thermal Shutdown

The MPQ2169 has thermal protection by monitoring the IC temperature internally. This function prevents the chip from operating at an exceedingly high temperature. If the junction temperature exceeds the threshold value (typically 175°C), it shuts down the whole chip. This is a non-latch protection. There is a 40°C hysteresis. Once the junction temperature drops to about 135°C, the device resumes operation by initiating a soft start.

APPLICATION INFORMATION

Setting the Output Voltage

The external resistor divider sets the output voltage. The feedback resistor (R1) also sets the feedback loop bandwidth with the internal compensation. The T-type network is recommended (see Figure 5).

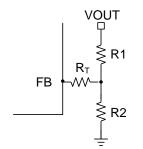


Figure 5: T-Type Feedback Network

 R_T + R1 is used to set the loop bandwidth. The lower R_T + R1 is, the higher the bandwidth will be. However, a high bandwidth may cause an insufficient phase margin, resulting in loop instability. Therefore, a proper R_T value is required to make a trade-off between the bandwidth and phase margin. Table 1 lists the recommended feedback resistor and R_T values for various output voltages.

R1 is estimated to be $100k\Omega$. R2 can then be calculated with Equation (2):

$$R2 = \frac{R1}{\frac{V_{OUT}}{0.6V} - 1}$$
(2)

Table 1: Resistor Selection vs. Output Voltage Setting

		-	
Vout	Rτ	R1	R2
1.2V	100kΩ	100kΩ	100kΩ
1.5V	100kΩ	100kΩ	66.5kΩ
1.8V	100kΩ	100kΩ	49.9kΩ
2.5V	100kΩ	100kΩ	31.6kΩ
3.3V	100kΩ	100kΩ	22.1kΩ

When the part works in FCCM, the max output voltage (V_{OUT}) must be limited to 0.5 x V_{IN} .

In the case of ceramic capacitors used as output capacitors (C_0), the feedback loop bandwidth (f_c) is no higher than 1/10 of the switching frequency for optimal transient performance and good phase margin. If an electrolytic capacitor is used, the loop

bandwidth is no higher than 1/4 of the ESR zero frequency (f_{ESR}).

f_{ESR} can be calculated by Equation (3):

$$f_{ESR} = \frac{1}{2\pi \times R_{ESR} \times C_{O}}$$
(3)

For example, choose f_C = 80kHz with a ceramic capacitor and C_O = 22 $\mu F.$

Selecting the Inductor

An inductor with a DC current rating at least 25% higher than the maximum load current is recommended for most applications. For the best efficiency, the inductor DC resistance should be less than $20m\Omega$. For most designs, the inductance value can be derived from Equation (4):

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_L \times f_{SW}}$$
(4)

Where ΔI_{\perp} is inductor ripple current. Choose the inductor ripple current to be approximately 30% of the maximum load current.

The maximum inductor peak current can be calculated with Equation (5):

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_{L}}{2}$$
(5)

Selecting the Input Capacitor

The input capacitor reduces the surge current drawn from the input and the switching noise from the device. The input capacitor impedance at the switching frequency should be less than the input source impedance to prevent high-frequency switching current from passing to the input source. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 22μ F capacitor is sufficient.

Selecting the Output Capacitor

The output capacitor (C_0) keeps the output voltage ripple small and ensures a stable regulation loop. The output capacitor impedance should be low at the switching frequency. Use ceramic capacitors with X5R or X7R dielectrics. If an electrolytic capacitor is used, pay close attention to the output ripple voltage, extra heating, and the selection of the

MPS Proprietary Information. Patent Protected. Unauthorized Photocopy and Duplication Prohibited. © 2025 MPS. All Rights Reserved. upper feedback resistor because of the large ESR of electrolytic capacitor (refer to the Setting the Output Voltage section). The output ripple (ΔV_{OUT}) can be approximated with Equation (6):

$$\Delta V_{OUT} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times L \times f_{SW}} \times (ESR + \frac{1}{8 \times f_{SW} \times Co})$$
(6)

Power Dissipation

IC power dissipation is important in circuit design, not only because of efficiency concerns, but also because of the chip's thermal requirements. Several parameters influence power dissipation, such as conduction loss (Cond), dead time (DT), switching loss (SW), MOSFET driver current (DR), and supply current (S).

Based on these parameters, estimate the power loss with Equation (7):

$$P_{LOSS} = P_{Cond} + P_{DT} + P_{SW} + P_{DR} + P_{S}$$
(7)

Thermal Regulation

Changes in the IC temperatures change the electrical characteristics, especially when the temperature exceeds the IC's recommended operating range. Managing the IC's temperature requires additional considerations to ensure that the IC runs within the maximum allowable temperature junction. Specific layout designs can improve the thermal profile while limiting costs to either the efficiency or operating range.

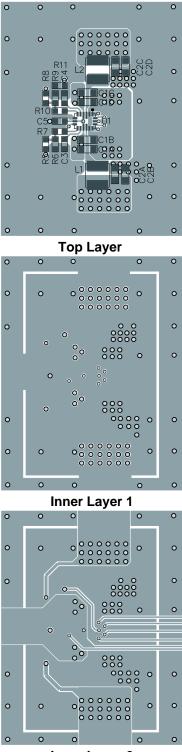
For the MPQ2169, connect the ground pin on the package to a ground plane on top of the PCB to use the plane as a heat sink. Connect this ground plane to the ground planes beneath the IC using vias to improve heat dissipation. Since these ground planes can introduce unwanted EMI noise and occupy valuable PCB space, design their size and shape to match the thermal resistance requirement. Connecting the ground pin to a heat sink does not guarantee that the IC will not exceed its recommended temperature limits (i.e.: the ambient temperature exceeds the IC's limits). lf the temperature ambient air temperature approaches the IC's temperature limit, the IC can be de-rated to operate using less power and help prevent thermal damage and unwanted electrical characteristics.

PCB Layout Guidelines (8)

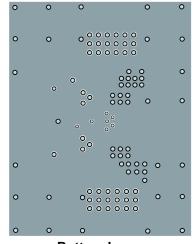
Efficient PCB layout is critical for stable operation. A four-layer layout is strongly recommended to achieve better thermal performance. For best results, refer to Figure 6 and follow the guidelines below.

- 1. Place the high-current paths (PGND, VIN, and SW) very close to the device with short, direct, and wide traces.
- 2. Place input capacitors on both VIN sides and as close to VIN and PGND as possible.
- 3. Place the decoupling capacitor as close to VCC and AGND as possible.
- 4. Keep the switching node SW short and away from the feedback network.
- 5. Place the external feedback resistors next to FB. Do not place vias on the FB trace.
- 6. Connect PGND to a large copper area to achieve better thermal performance.
- 7. PGND1, PGND2, and AGND must be connected together on board externally.





Inner Layer 2



Bottom Layer Figure 6: Recommended PCB Layout

Note: 8) The recommended PCB layout is based on Figure 7.

TYPICAL APPLICATION CIRCUITS

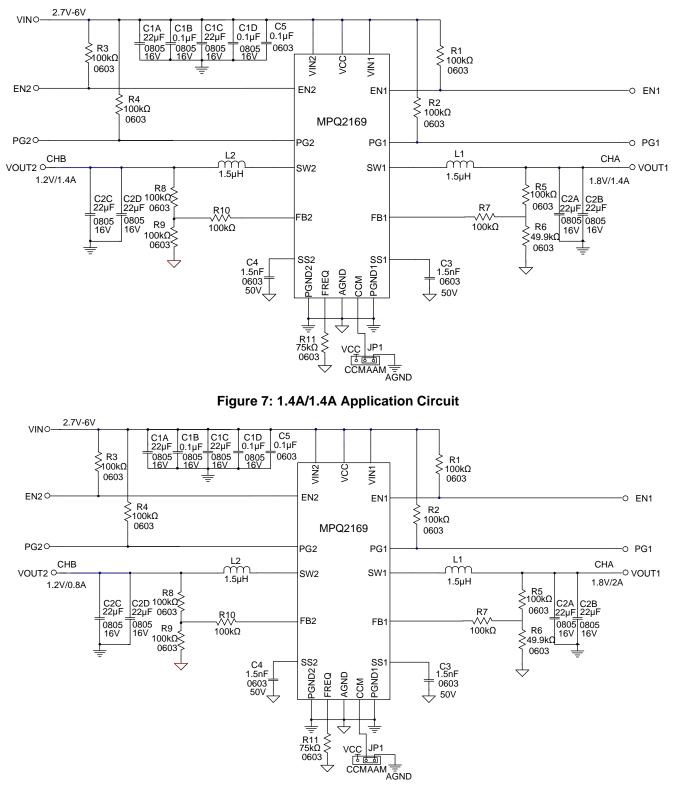
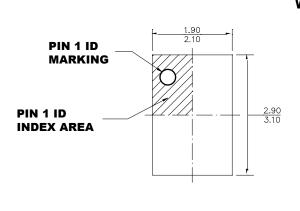


Figure 8 : 2A/0.8A Application Circuit

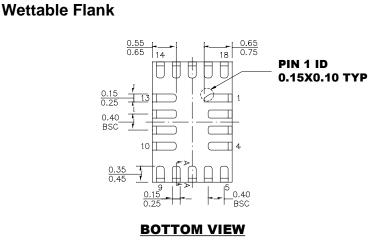


QFN-18 (2mmx3mm)

PACKAGE INFORMATION

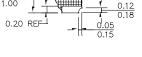


TOP VIEW

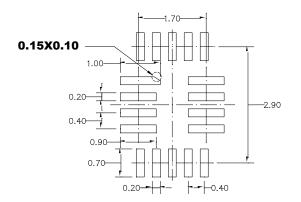




SIDE VIEW



SECTION A-A



RECOMMENDED LAND PATTERN

NOTE:

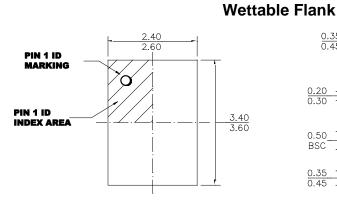
0.80

 THE LEAD SIDE IS WETTABLE.
 ALL DIMENSIONS ARE IN MILLIMETERS.
 LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX.
 JEDEC REFERENCE IS MO-220.
 DRAWING IS NOT TO SCALE.

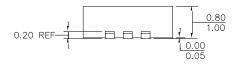


QFN-18 (2.5mmx3.5mm)

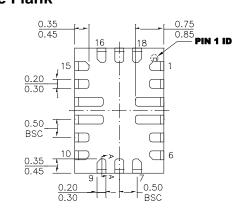
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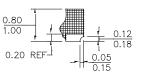




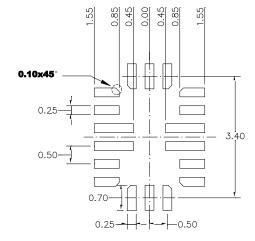
SIDE VIEW



BOTTOM VIEW



SECTION A-A

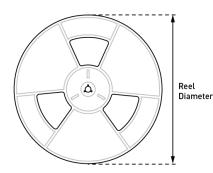


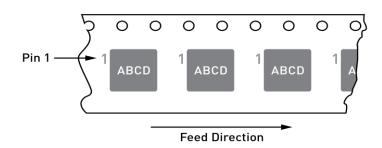
RECOMMENDED LAND PATTERN

NOTE:

 1) THE LEAD SIDE IS WETTABLE.
 2) LAND PATTERNS OF PIN3, 4, 12 AND 13 HAVE THE SAME LENGTH AND WIDTH.
 3) ALL DIMENSIONS ARE IN MILLIMETERS.
 4) LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX.
 5) JEDEC REFERENCE IS MO-220.
 6) DRAWING IS NOT TO SCALE.

CARRIER INFORMATION





Part Number	Package Description	Quantity /Reel	Quantity/ Tube*	Reel Diameter	Carrier Tape Width	Carrier Tape Pitch
MPQ2169GDE-AEC1-Z	QFN-18 (2mmx3mm)	5000	N/A	12:5	10mm	9mm
MPQ2169GRHE-AEC1-Z	QFN-18 (2.5mmx3.5mm)	5000	N/A	13in.	12mm	8mm

* N/A indicates "not available" in tubes. For 500 piece tape & reel prototype quantities, see factory. (Order code for 500 piece partial reel is "-P", tape & reel dimensions same as full reel.)

REVISION HISTORY

Revision #	Revision Date	Description	Pages Updated
1.0	8/23/2018	Initial Release	-
		Added three auto relative applications: Automotive infotainment Automotive Clusters	1
		Automotive Telematics Added MSL Ratings, ESD and Carrier Information	3, 5, 25
		Added the thermal resistor on EVB	5
		Retested load/line regulation and the efficiency with AAM and CCM load	9, 10
		Added some TC curves	7, 8
1.1	5/12/2020	Added some content to Pin Description section	4
1.1	5/12/2020	Added the Enable description in operation part	17
		Added the Thermal Shutdown section	18
		Deleted the NC parts in the Typical Application Circuit section	22
		Updated the layout based on the Typical Application Circuit section	21
		Added the contents starting with "Ensure to add the external SYNC clock"	18
		Add the compensation parameters and modify Vcc connection in the functional block.	16
		Added "when the part works in AAM mode" to "is capable of low dropout configurations" in the Description section; Added "in AAM Mode, 0.6V to 0.5 x V _{IN} in FCCM" to "Adjustable 0.6V to 5.5V Output" in the Features section; Minor formatting updates.	1
		Updated the output voltage to " $0.6V$ to $5.5V$ in AAM mode; 0.6V to $0.5 \times V_{IN}$ in FCCM" in the Recommended Operating Conditions section; Added note (3) to Output voltage in the Recommended Operating Conditions section.	5
1.2	5/23/2025	Update note numbers.	5, 6, 20–21
1.2	5/23/2025	Added "When the part works in FCCM, the max output voltage (V_{OUT}) must be limited to 0.5 x V_{IN} " to the Light-Load Operation section.	17
		Minor grammatical updates to the Soft Start (SS) and Power Good (PG) sections; Added "Do not use FCCM in applications that can be subject to dropout operation" to the Dropout Operation section.	18
		Added "When the part works in FCCM, the max output voltage (V_{OUT}) must be limited to 0.5 x V_{IN} " to the Setting the Output Voltage section.	20

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